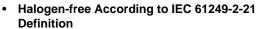


N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
60	$0.032 \text{ at V}_{GS} = 10 \text{ V}$	35 ^d	21.7			
00	$0.037 \text{ at V}_{GS} = 4.5 \text{ V}$	30 ^d	21.7			

FEATURES

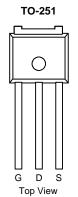


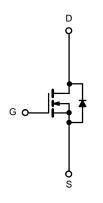


100 % R_g and UIS Tested

Compliant to RoHS Directive 2002/95/EC







N-Channel MOSFET

APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- DC/DC Converter

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	60	V			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	I _D	35 ^d	Α		
Goriandous Brain Gurrent (1) = 130 G)	T _C = 70 °C	טי	30 ^d			
Pulsed Drain Current	I _{DM}	100	Α			
Avalanche Current		I _{AS}	40			
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	80	mJ		
Manifesture Danier Diseir etiani	T _C = 25 °C	P _D	59.5 ^b	W		
Maximum Power Dissipation ^a	T _A = 25 °C ^c		2.7			
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	46	°C/W		
Junction-to-Case (Drain)	R _{thJC}	2.1	C/VV		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

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SPECIFICATIONS $T_J = 25^{\circ}$	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Syllibol	rest conditions	IVIIII.	тур.	IVIAA.	Oilit	
		V 0.V I 050 v A	- 00				
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2.0		3.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Drain-Source On-State Resistance ^a	D	$V_{GS} = 10 \text{ V}, I_{D} = 12 \text{ A}$		0.032		Ω	
Dialii-Source Ori-State Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.037			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		110		S	
Dynamic ^b			•				
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz		1100		pF	
Output Capacitance	C _{oss}			281			
Reverse Transfer Capacitance	C _{rss}			130			
Total Cata Channel	Q _g	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		46		nC	
Total Gate Charge ^c				28			
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		7			
Gate-Drain Charge ^c	Q _{gd}			6.7			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16	ns	
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, R_1 = 1.5 \Omega$		9	18		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53		
Fall Time ^c	t _f	, and the second		9	18		
Drain-Source Body Diode Ratings a	nd Characteris	stics T _C = 25 °C ^b	l				
Continuous Current	Is	-			50		
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V		0.75	1.5	V	
Reverse Recovery Time	t _{rr}			34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	$I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		2	3	Α	
Reverse Recovery Charge	Q _{rr}			34	51	nC	

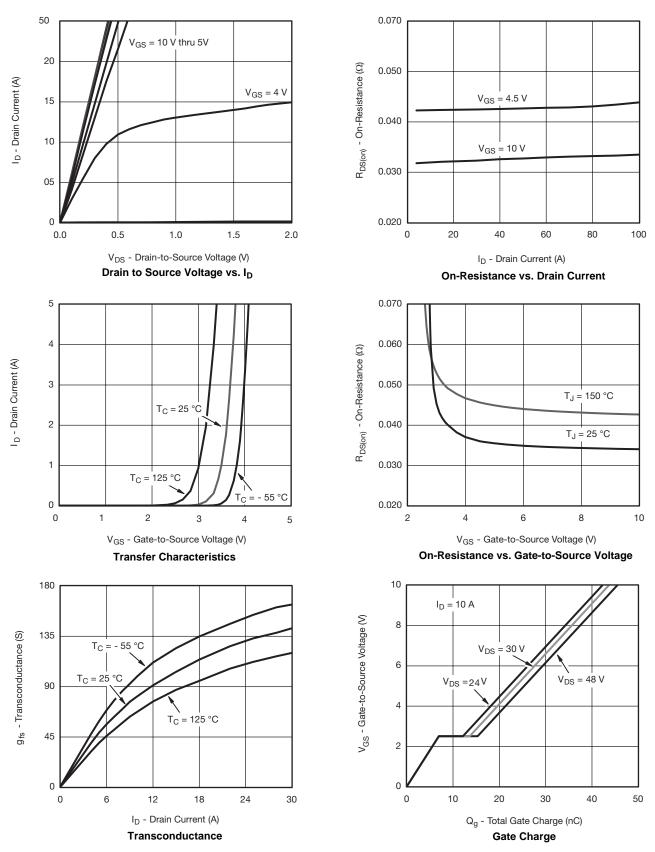
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

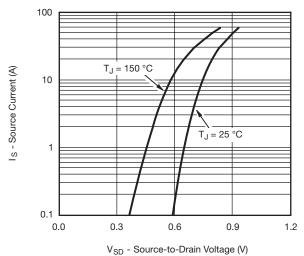


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

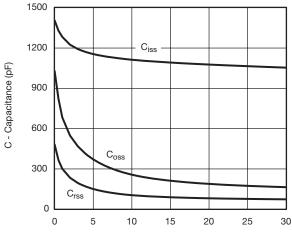




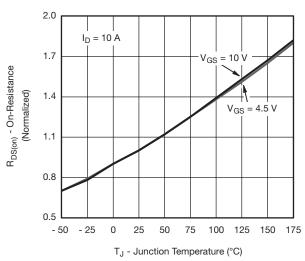
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



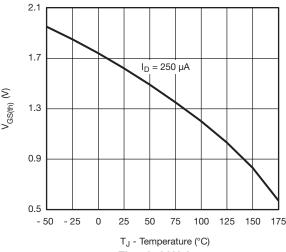
Source-Drain Diode Forward Voltage



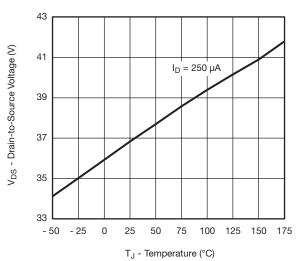
 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$



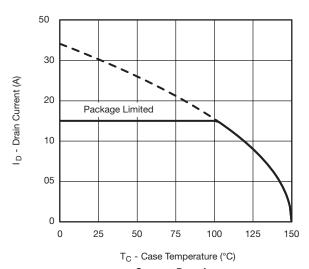
On-Resistance vs. Junction Temperature



Threshold Voltage



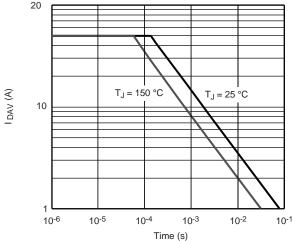
Drain Source Breakdown vs. Junction Temperature

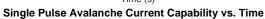


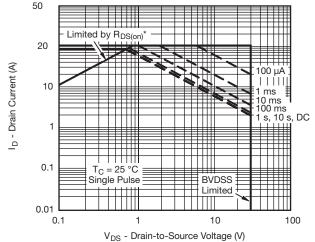
Current Derating



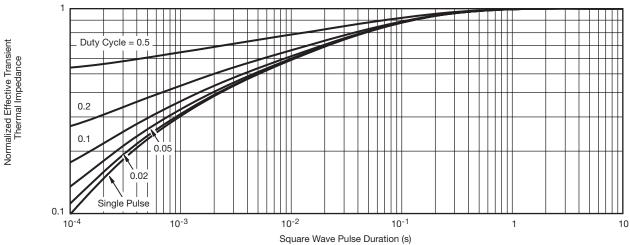
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







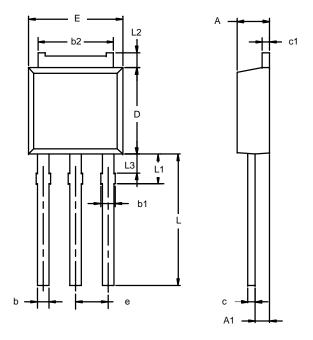
 * V $_{GS}$ > minimum V $_{GS}$ at which R $_{DS(on)}$ is specified Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIM	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
E	6.48	6.73	0.255	0.265
е	2.28	2.28 BSC		BSC
L	8.89	9.53	0.350	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346				

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